

**M74HCT245-1P/FP****OCTAL 3-STATE  
NONINVERTING BUS TRANSCEIVER WITH LSTTL-COMPATIBLE INPUTS****DESCRIPTION**

The M74HCT 245-1 is an integrated circuit chip consisting of eight transceivers with noninverted outputs.

**FEATURES**

- TTL level inputs  $V_{IL}=0.8V$  max,  $V_{IH}=2.0V$  min
- High-fanout 3-state output : ( $I_{OL}=24mA$ ,  $I_{OH}=-24mA$ )
- High-speed : 11ns typ. ( $C_L=50pF$ ,  $V_{CC}=5V$ )
- Low power dissipation :  $25\mu W$ /package, max ( $V_{CC}=5V$ ,  $T_a=25^\circ C$ , quiescent state)
- Capable of driving 60 74LSTTL loads
- Wide operating temperature range :  $T_a=-40\sim+85^\circ C$

**APPLICATION**

General purpose, for use in industrial and consumer digital equipment.

**FUNCTION**

Use of silicon gate technology allows the M74HCT245-1 to maintain the low power dissipation and high noise margin characteristics of the standard CMOS logic 4000B series while giving high-speed performance equivalent to the 74LS245. The circuit is designed to suppress the increased switching noise that normally occurs at high output currents. As the inputs are TTL level, the device can be used as a level converter from LSTTL to high-speed CMOS. When used as such, no pull-up resistors are required.

Two buffers with 3-state noninverted outputs have their inputs and outputs connected and can be used as buffers in both directions.

The input/output direction is controlled by directions input DIR.

When DIR is high, the A data ports will become input terminals and the B data ports will become output terminals.

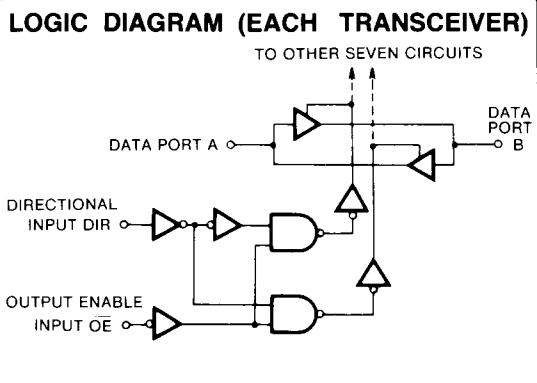
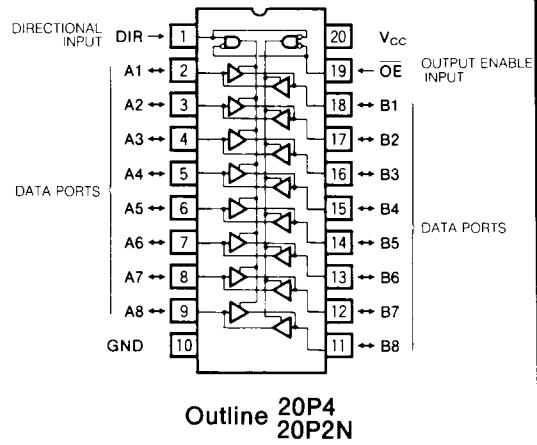
When DIR is low, B will become input terminals and A will become output terminals.

When output enable OE is high, A and B will both become high-impedance state and they will be separated.

**FUNCTION TABLE** (Note 1)

Inputs		Data ports	
OE	DIR	A	B
L	L	O	I
L	H	I	O
H	X	Z	Z

Note 1 : I : Input pin  
 O : Output pin  
 Z : High impedance (A and B are separated.)  
 X : Irrelevant

**PIN CONFIGURATION (TOP VIEW)**

**OCTAL 3-STATE  
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**ABSOLUTE MAXIMUM RATINGS** ( $T_a = -40 \sim +85^\circ\text{C}$ , unless otherwise noted)

Symbol	Parameter	Conditions	Ratings	Unit
$V_{CC}$	Supply voltage		-0.5 ~ +7.0	V
$V_I$	Input voltage		-0.5 ~ $V_{CC} + 0.5$	V
$V_O$	Output voltage		-0.5 ~ $V_{CC} + 0.5$	V
$I_{IK}$	Input protection diode current	$V_I < 0V$	-20	
		$V_I > V_{CC}$	20	mA
$I_{OK}$	Output parasitic diode current	$V_O < 0V$	-20	
		$V_O > V_{CC}$	20	mA
$I_O$	Output current		$\pm 50$	mA
$I_{CC}$	Supply/GND current	$V_{CC}, GND$	$\pm 200$	mA
$P_d$	Power dissipation	(Note 2)	500	mW
$T_{STG}$	Storage temperature		-65 ~ +150	$^\circ\text{C}$

Note 2 : M74HCT245-1FP :  $T_a = -40 \sim +75^\circ\text{C}$  and  $T_a = 75 \sim 85^\circ\text{C}$  are derated at  $-7\text{mW}/^\circ\text{C}$

**RECOMMENDED OPERATING CONDITIONS** ( $T_a = -40 \sim +85^\circ\text{C}$ )

Symbol	Parameter	Limits			Unit
		Min	Typ	Max	
$V_{CC}$	Supply voltage	4.5	5.5	V	
$V_I$	Input voltage	0	$V_{CC}$	V	
$V_O$	Output voltage	0	$V_{CC}$	V	
$T_{OPR}$	Operating temperature	-40	+85	$^\circ\text{C}$	
$t_r, t_f$	Input rise time, fall time	$V_{CC}=4.5\text{V}$ $V_{CC}=5.5\text{V}$	0 0	25 15	ns/V

**ELECTRICAL CHARACTERISTICS** ( $V_{CC}=5\text{V} \pm 10\%$ , unless otherwise noted)

Symbol	Parameter	Test conditions	Limits				Unit
			25°C	-40~+85°C			
$V_{IH}$	High-level input voltage	$V_O=0.1V, V_{CC}=0.1V$ $ I_O =20\mu\text{A}$	2.0			2.0	V
$V_{IL}$	Low-level input voltage	$V_O=0.1V, V_{CC}=0.1V$ $ I_O =20\mu\text{A}$			0.8	0.8	V
$V_{OH}$	High-level output voltage	$V_I=V_{IH}, V_{IL}$ $ I_{OH} =-20\mu\text{A}, V_{CC}=4.5\text{V}$	$V_{CC}-0.1$ 3.83			$V_{CC}-0.1$ 3.70	V
$V_{OL}$	Low-level output voltage	$V_I=V_{IL}$ $ I_{OL} =20\mu\text{A}$ $ I_{OL} =24\text{mA}, V_{CC}=4.5\text{V}$		0.1		0.1	V
$I_{IH}$	High-level input current	$V_I=V_{CC}$		0.1		1.0	$\mu\text{A}$
$I_{IL}$	Low-level input current	$V_I=GND$		-0.1		-1.0	$\mu\text{A}$
$I_{OZH}$	Off-state high-level output current	$V_I=V_{IH}, V_{IL}, V_O=V_{CC}$		0.5		5.0	$\mu\text{A}$
$I_{OZL}$	Off-state low-level output current	$V_I=V_{IH}, V_{IL}, V_O=GND$		-0.5		-5.0	$\mu\text{A}$
$I_{CC}$	Static supply current	$V_I=V_{CC}, GND, I_O=0\mu\text{A}$		5.0		50.0	$\mu\text{A}$
$I_{CC}$	Maximum static supply current	$V_I=2.4\text{V}, 0.4\text{V}$ (Note 3)		2.7		2.9	mA

Note 3 : Only one input is set at this value. All others are fixed to  $V_{CC}$  and GND.

**SWITCHING CHARACTERISTICS** ( $V_{CC}=5\text{V}, T_a=25^\circ\text{C}$ )

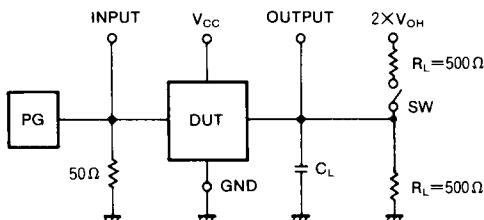
Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
$t_{TLH}$	Low-to high-level and high-to low-level output transition time			10		ns
$t_{THL}$				10		ns
$t_{PLH}$	Low-to high-level and high-to low-level output propagation time (A-B, B-A)	$C_L=50\text{pF}$ (Note 5)		18		ns
$t_{PML}$				20		ns
$t_{PLZ}$	Low-level and high-level output disable time ( $\text{OE}=A, B$ )	$C_L=5\text{pF}$ (Note 5)		27		ns
$t_{PZL}$	Low-level and high-level output enable time ( $\text{OE}=A, B$ )	$C_L=50\text{pF}$ (Note 5)		27		ns
$t_{PZH}$				29		ns
				29		ns

**OCTAL 3-STATE  
NONINVERTING BUS TRANSCEIVER WITH LSTTL-COMPATIBLE INPUTS**
**SWITCHING CHARACTERISTICS** ( $V_{CC}=5V \pm 10\%$ ,  $T_a=-40 \sim +85^\circ C$ )

Symbol	Parameter	Test conditions	Limits					Unit	
			25°C		-40~+85°C				
			Min	Typ	Max	Min	Max		
$t_{TLH}$	Low-to high-level and high-to low-level output transition time			5	12		15	ns	
$t_{THL}$				5	12		15	ns	
$t_{PLH}$	Low-to high-level and high-to low-level output propagation time (A-B, B-A)			9	19		24	ns	
$t_{PHL}$				12	21		26	ns	
$t_{PLZ}$	Low-level and high-level output disable time ( $\bar{OE}=A, B$ )			10	30		38	ns	
$t_{PHZ}$				13	30		38	ns	
$t_{PZL}$	Low-level and high-level output enable time ( $\bar{OE}=A, B$ )			12	30		38	ns	
$t_{PZH}$				11	30		38	ns	
$C_I$	Input capacitance					10	10	pF	
$C_O$	Off-state output capacitance	$\bar{OE}=V_{CC}$				15	15	pF	
$C_{PD}$	Power dissipation capacitance (Note 4)					62.0		pF	

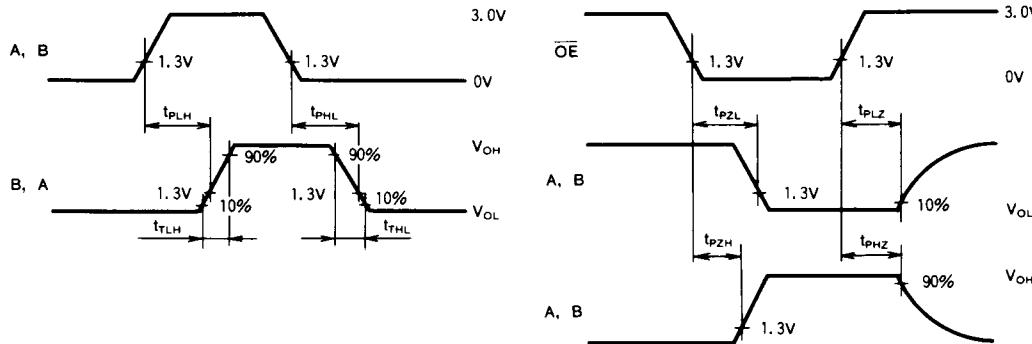
Note 4 :  $C_{PD}$  is the internal capacitance of the IC calculated from operation supply current under no-load conditions (per buffer). The power dissipated during operation under no-load condition is calculated using the following formula :  
 $P_D = C_{PD} \cdot V_{CC}^2 \cdot f_t + I_{CC} \cdot V_{CC}$

Note 5 : Test Circuit



Parameter	SW
$t_{TLH}, t_{THL}$	Open
$t_{PLH}, t_{PHL}$	Closed
$t_{PLZ}$	Closed
$t_{PHZ}$	Open
$t_{PZL}$	Closed
$t_{PZH}$	Open

- (1) The pulse generator (PG) has the following characteristics (10%~90%)  $t_r=3ns$ ,  $t_f=3ns$   
(2) The capacitance  $C_L$  includes stray wiring capacitance and the probe input capacitance.

**TIMING DIAGRAM**


**MITSUBISHI HIGH SPEED CMOS  
PACKAGE OUTLINES**

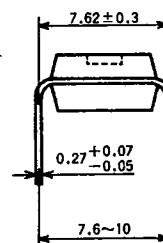
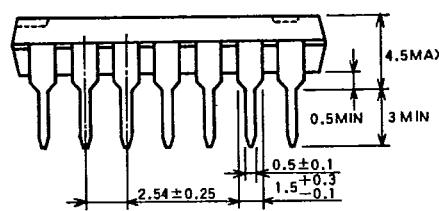
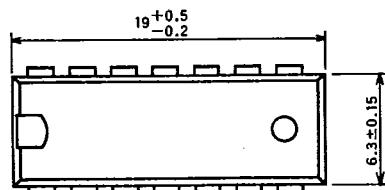
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91D 12849

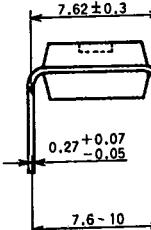
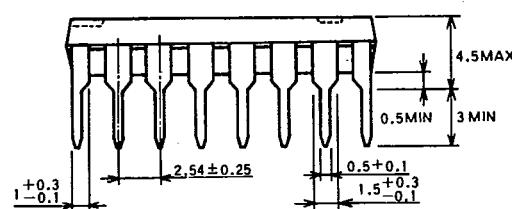
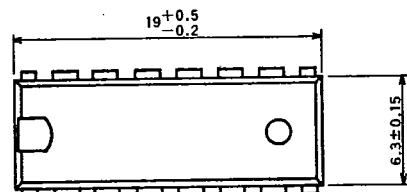
D T-90-20

**TYPE 14P4 14-PIN MOLDED PLASTIC DIP**

Dimension in mm

**TYPE 16P4 16-PIN MOLDED PLASTIC DIP**

Dimension in mm

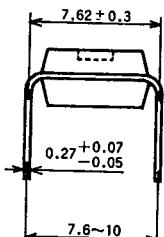
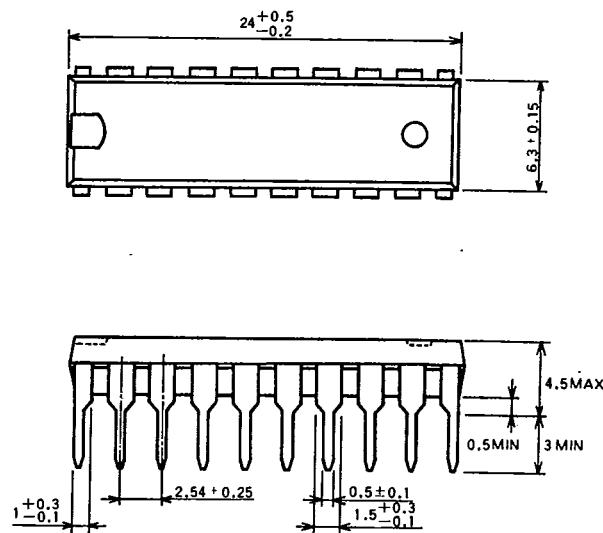


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PACKAGE OUTLINES

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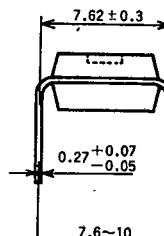
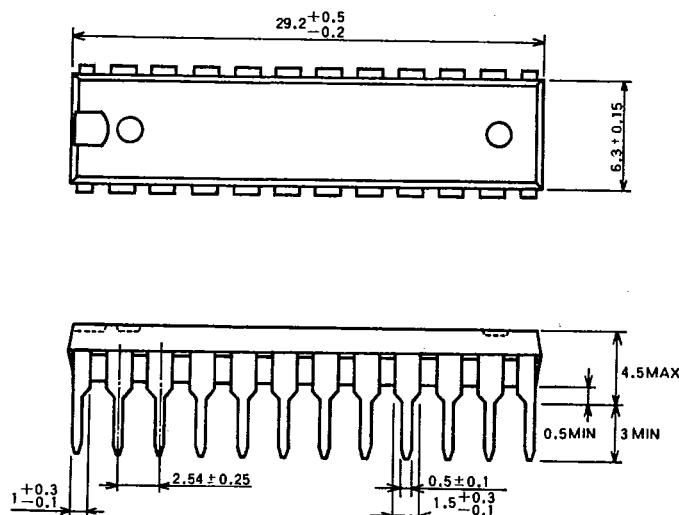
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Dimension in mm



## TYPE 24P4D 24-PIN MOLDED PLASTIC DIP

Dimension in mm



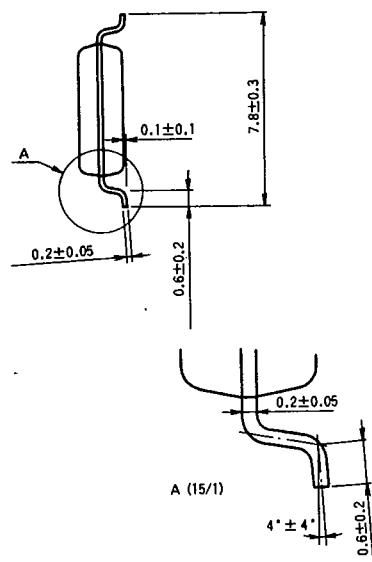
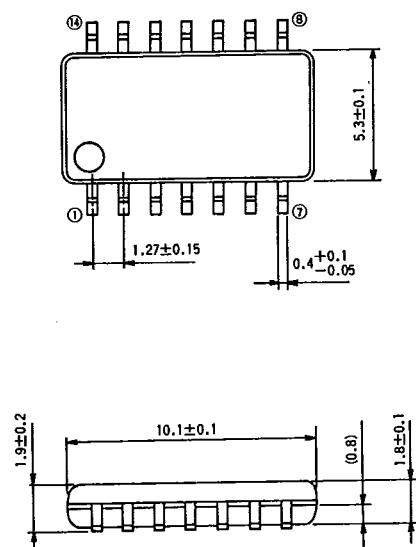
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PACKAGE OUTLINES

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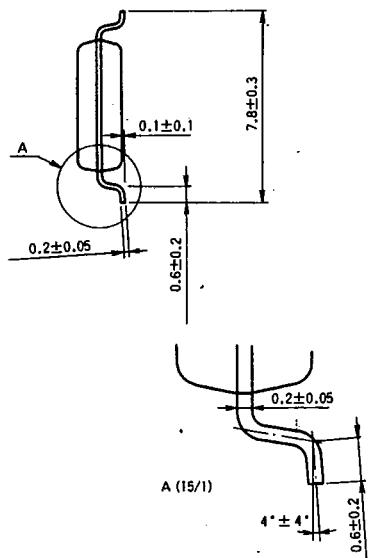
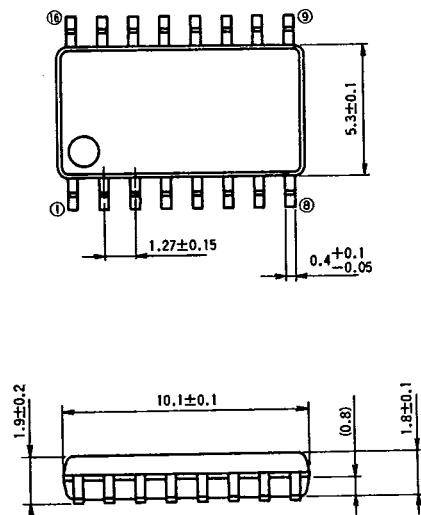
TYPE 14P2N 14PIN MOLDED PLASTIC SOP

Dimension in mm



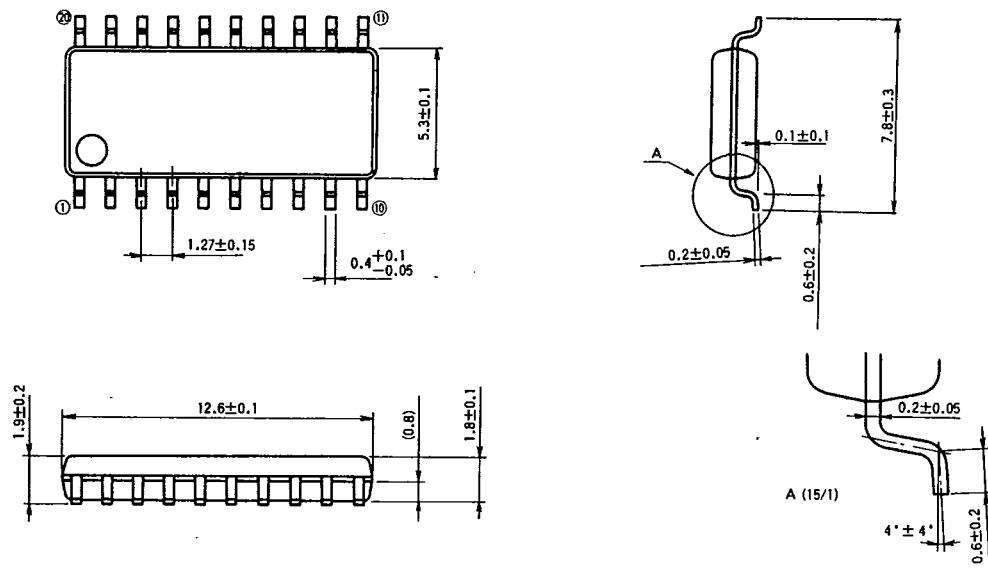
TYPE 16P2N 16PIN MOLDED PLASTIC SOP

Dimension in mm



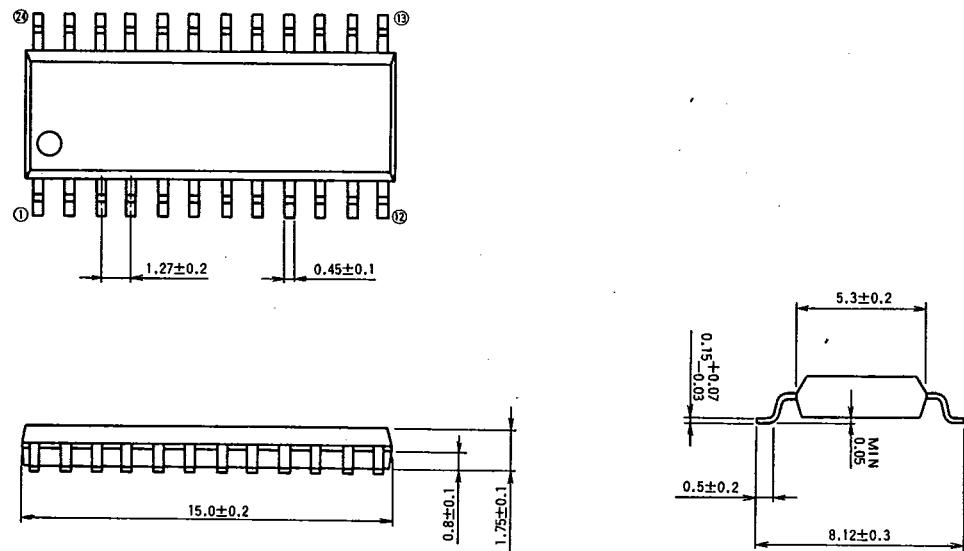
## TYPE 20P2N 20PIN MOLDED PLASTIC SOP

Dimension in mm



## TYPE 24P2 24PIN MOLDED PLASTIC SOP

Dimension in mm

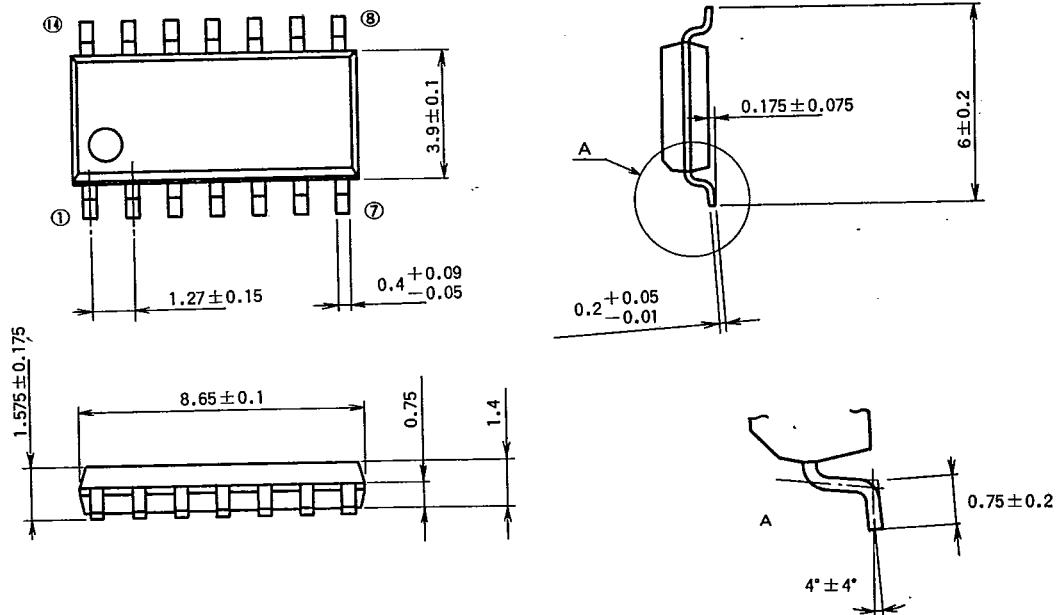


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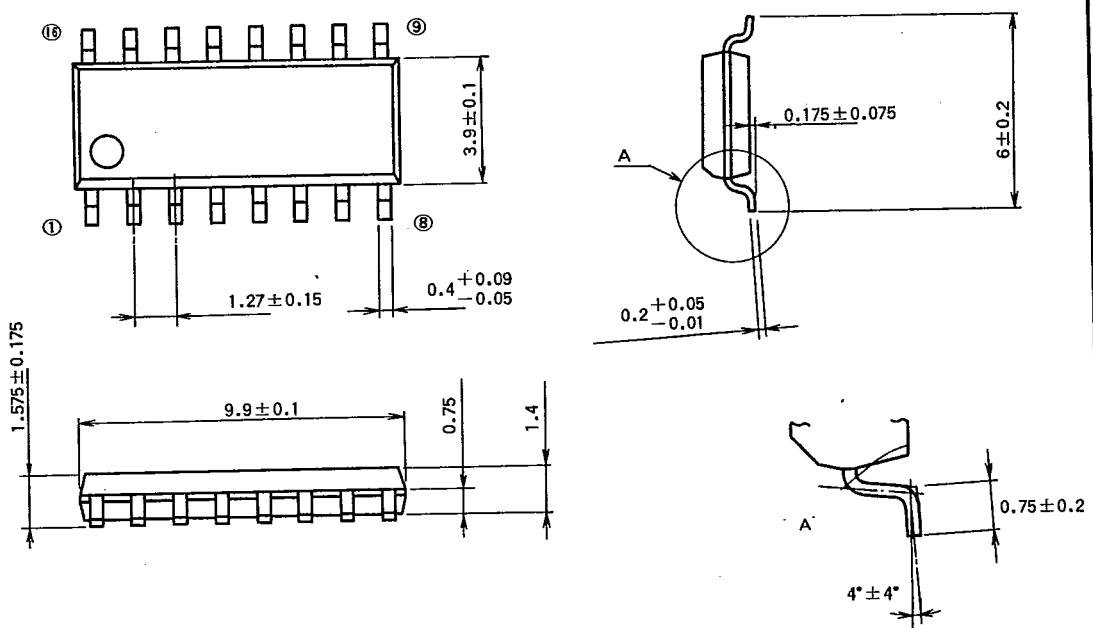
## TYPE 14P2P 14-PIN MOLDED PLASTIC SOP(JEDEC 150mil body)

Dimension in mm



## TYPE 16P2P 16-PIN MOLDED PLASTIC SOP(JEDEC 150mil body)

Dimension in mm



## PACKAGE OUTLINES

6249827 MITSUBISHI (DGTL LOGIC)

91D 12854 D T-90-20

## TYPE 20P2V 20-PIN MOLDED PLASTIC SOP(JEDEC 300mil body)

